ASSOCIATION ELECTRONICS	N CONNECTING S INDUSTRIES® in	Material Composit Copyright 2005. IPC, nternational and Pan-An	t <b>ion Dec</b> Bannockb nerican co	claration ourn, Illinois. A opyright conver	ll rights reserved untions.	nder both	This docum level parts,	ent is a c	declaratior aration enc	of the substa compasses all l	nces wi	thin the manufacture evel materials for wh	er listed i	item. Note: if th manufacturer ha	e item is an assem s engineering resp	bly with lower onsibility.
1752-21.1 IPC Web Site for Information on II http://www.ipc.org/IPC-175x							*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information			
Supplier	· Informati	on														
Company name*			Company unique ID				Unique ID Authority					Response Date*				
onsemi													2024-05-20			
Contact Name				Title - Contac	Title - Contact				Phone - Contact*				Email - Contact*			
Product-Env-Stewards				Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized	Authorized Representative*				Title - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		Number Mfr Item Name				Effecti	ive Date	Version	Mai	Manufacturing Site		Weight*	UOM	Unit Type	
	NCV772			6DQBR2G	DQBR2G Automotive Driver			2024-0	)5-20		PHO	HG		168.51	mg	Each
Manufacturing Process Information																
Terminal Plating / Grid Array Material T			Terminal Base Alloy J-STD-020 MSI			L Rating	Peak Process Body Temperature Max Time at Peak			Temperature Number of Reflow Cycles						
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 2		2		<b>260</b> C			30 seco		seconds 3				
Comments																
ATTENTION: MSL 2 Rated item requires Dry Pack (after electrical test)																
For more information regarding material composition please refer to page 3																

RoHS Material Composition Declaration			Declaration Type *	Detail	ed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).												
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is troughter of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.												
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the							

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.71	mg	Supplier	Silicon (Si)	7440-21-3		4.71	mg
Die Attach	1.0	mg	Supplier	Silver (Ag)	7440-22-4		0.75	mg
			Supplier	Epoxy resins	129915-35-1		0.25	mg
Lead Frame	60.56	mg	Supplier	Zinc (Zn)	7440-66-6		0.0606	mg
			Supplier	Iron (Fe)	7439-89-6		1.3929	mg
			Supplier	Copper (Cu)	7440-50-8		59.046	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0606	mg
Mold Compound-Black	100.79	mg		Epoxy resin	proprietary data		7.5593	mg
			Supplier	Phenolic Resin	Proprietary Data		2.5198	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		7.5593	mg
			Supplier	Carbon Black (C)	1333-86-4		0.5039	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		82.6478	mg
Plating	0.47	mg	Supplier	Palladium (Pd)	7440-05-3		0.0113	mg
			В	Nickel (Ni)	7440-02-0		0.4136	mg
			Supplier	Gold (Au)	7440-57-5		0.0451	mg
Wire Bond - Au	0.98	mg	Supplier	Gold (Au)	7440-57-5		0.98	mg